



Washkewicz College
of Engineering




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**Wireless Temperature
and Pressure Sensors
for STERIS Controller**

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Outline

- Problems & Objectives
- Design Concept
- Wireless Technologies
- Deliverables
- Budget
- Professional Awareness
- Timeline



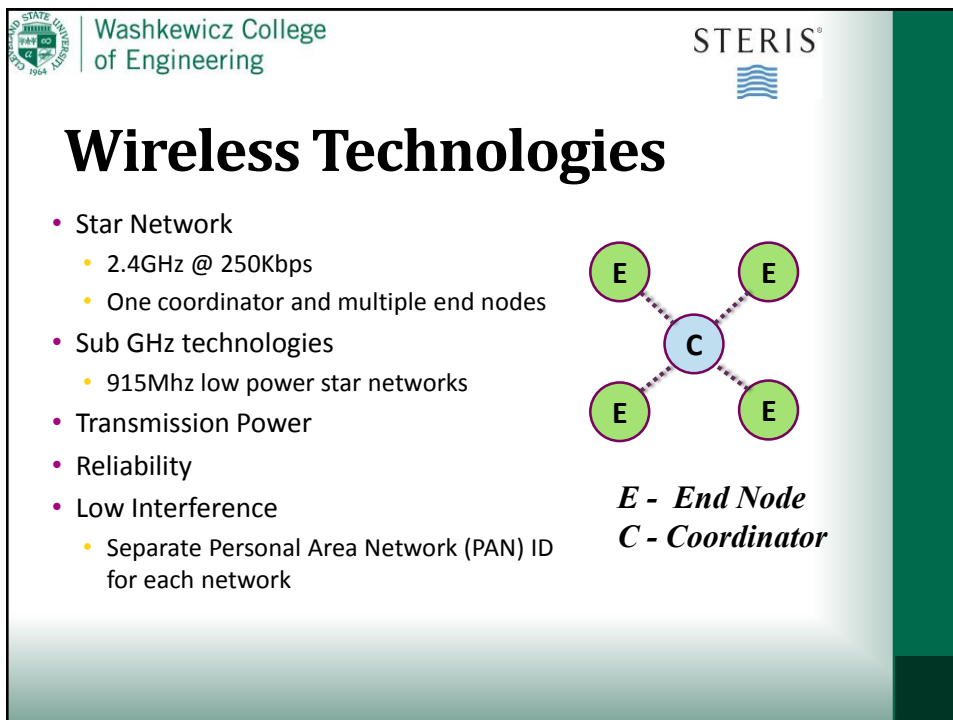
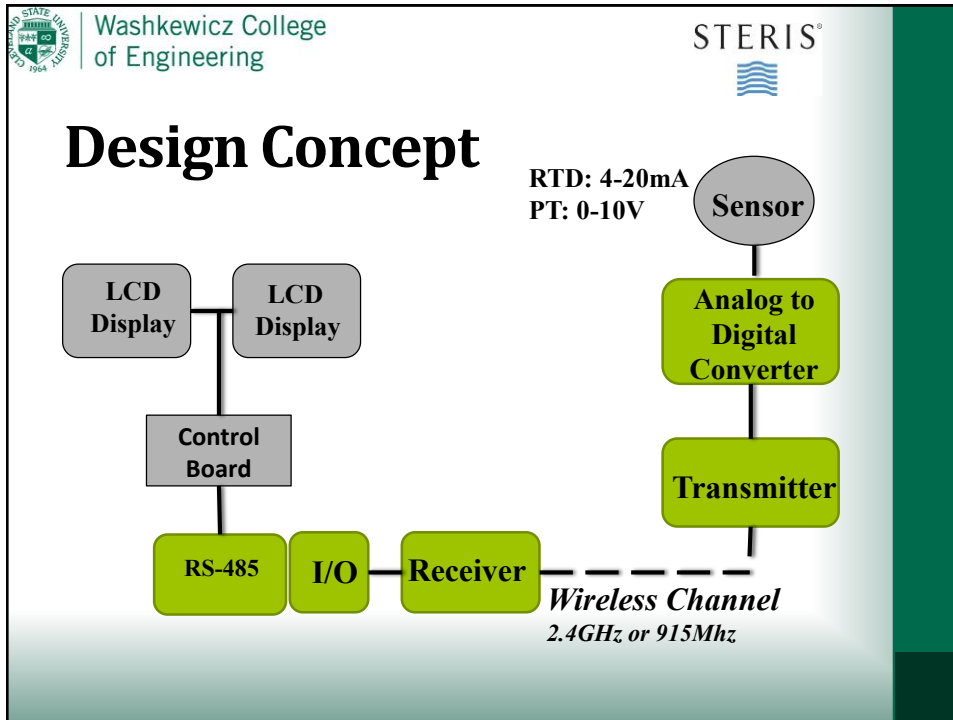
Problems & Objectives

- Create wireless sensor solution
- Steam sterilization units
- Large metal chambers that involve wiring of:
 - Sensors
 - PC Board
 - User Interface
 - Safeties Interlocks
- Installation hassle and cost
- Limited scalability
- Wires touching hot surfaces



Design Concept

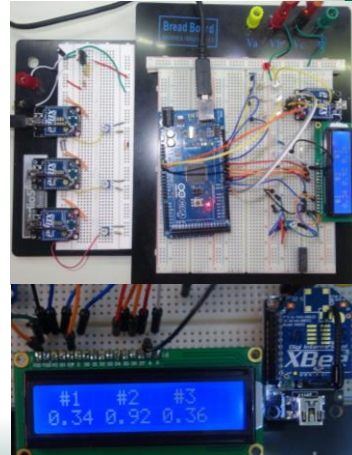
- Wireless Technologies
 - IEEE 802.15.4 protocol - Low data rate wireless personal area networks (WPAN)
 - ZigBee or low power star networks
 - 2.4Ghz vs Sub 1Ghz (915Mhz) frequencies
- Sensor Interface
 - Analog to digital circuit
 - Resistance Temperature Detectors (RTD) → 0-10Volts
 - Pressure Transducer (PT) → 4-20mA
- RS-485 Ethernet Communications
- Software Development





Wireless Technologies


- Xbee and Arduino
 - Proof of concept
 - Transmit voltage at Xbee A/D input
 - 0-1.2 Volts
 - 3 end nodes & 1 coordinator
- Provides understanding of RF transmission




Deliverables



- 2.4GHz or Sub GHz (915Mhz) star network system
- 10 bit or more A/D
- 24VDC plug in power supply
 - Possibility of future cordless power solutions
- ARM Cortex micro-processor options
 - Mbed enabled board
 - Platform based off Atmel SAM D21 evaluation kit
- Common board for different types of sensors
- PCB design and working device
- Software interface with main controller




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Budget


| | |
|---------------------|--------------------------|
| Xbee XB24CZ7UIS-004 | Atmel ATZB-RF-233-1-C-ND |
| \$ 17.50 per board | \$29.62 per board |


Estimates of other Expenses (Excluding Manufacturing)

| | |
|-----------------------------|---------------------------|
| ARM Cortex Processor | \$2-4 per board |
| Misc. electronic components | \$10-20 per board |
| PCB Blanks | \$15-25 per board |
| Wireless Module | \$17.50 – 29.62 per board |

| | |
|----------------------------------|----------------------------------|
| Total Per Completed Board | \$44.50 – 78.62 per board |
|----------------------------------|----------------------------------|

** All prices estimated from www.Digikey.com **


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Professional Awareness

- Responsibility to make product secure
 - Ensure privacy of STERIS information
 - Prevent solution from being abused as backdoor to access STERIS client (e.g., hospitals, research centers) networks
- Develop solution that embodies the best choice based on facts and test results, and not the one most in favor
 - Prioritize security
 - Prioritize safety
- Understand the end goal and purpose
- Realize the future potential of wireless sensor applications within STERIS



Timeline

| TASK | DURATION | WHO | September | | | October | | | November | | | December | | | January | | | February | | | March | | | April | | | May | | |
|---------------------------|----------|-------------|-----------|----|----|---------|---|----|----------|----|---|----------|----|----|---------|---|----|----------|----|---|-------|----|----|-------|----|----|-----|----|---|
| | | | 14 | 25 | 29 | 30 | 1 | 13 | 20 | 23 | 2 | 10 | 17 | 20 | 1 | 4 | 12 | 19 | 26 | 2 | 16 | 23 | 15 | 23 | 29 | 12 | 19 | 26 | 3 |
| TEAM BUILDING | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Interview with STERIS | 1d | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Meeting Time and | 1d | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Select group leader | 1d | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Tasks Assignment | | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Sign Contract with STERIS | | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| RESEARCH STRATEGY | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| 2.4Ghz vs 915 MHz testing | | AG, NY, AMF | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Research protocols | | AA, AMF | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Hardware design | | AA, AG | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Sensor integration | | AG | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Software implementation | | AMF, NY | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| PROTOTYPE | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Order parts | | AA, AG | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Assemble | | AA, AG | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Test | | AMF, AG | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Alpha prototype complete | | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Client Reaction | | AA, NY | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Refactor, Beta product | | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| REPORT | | | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Midterm presentation | | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Proposal | | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |
| Final Report | | ALL | | | | | | | | | | | | | | | | | | | | | | | | | | | |